

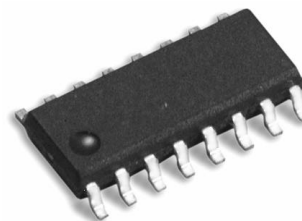
## STEPPING MOTOR DRIVER

The KA3100D is a monolithic integrated circuit, and suitable as a two-phase stepping motor driver of a FDD system.

## FEATURES

- Built-in vertical PNP power transistors
- Wide supply voltage ( $V_{CC} = 2.5V \sim 7.0V$ )
- Low saturation voltage ( $0.4@ 0.4A$ )
- Built-in chip enable function
- Built-in shoot-through current protector
- Built-in thermal shutdown function
- Built-in current-mode control circuit ( $I_{PEAK}: 1A$ )

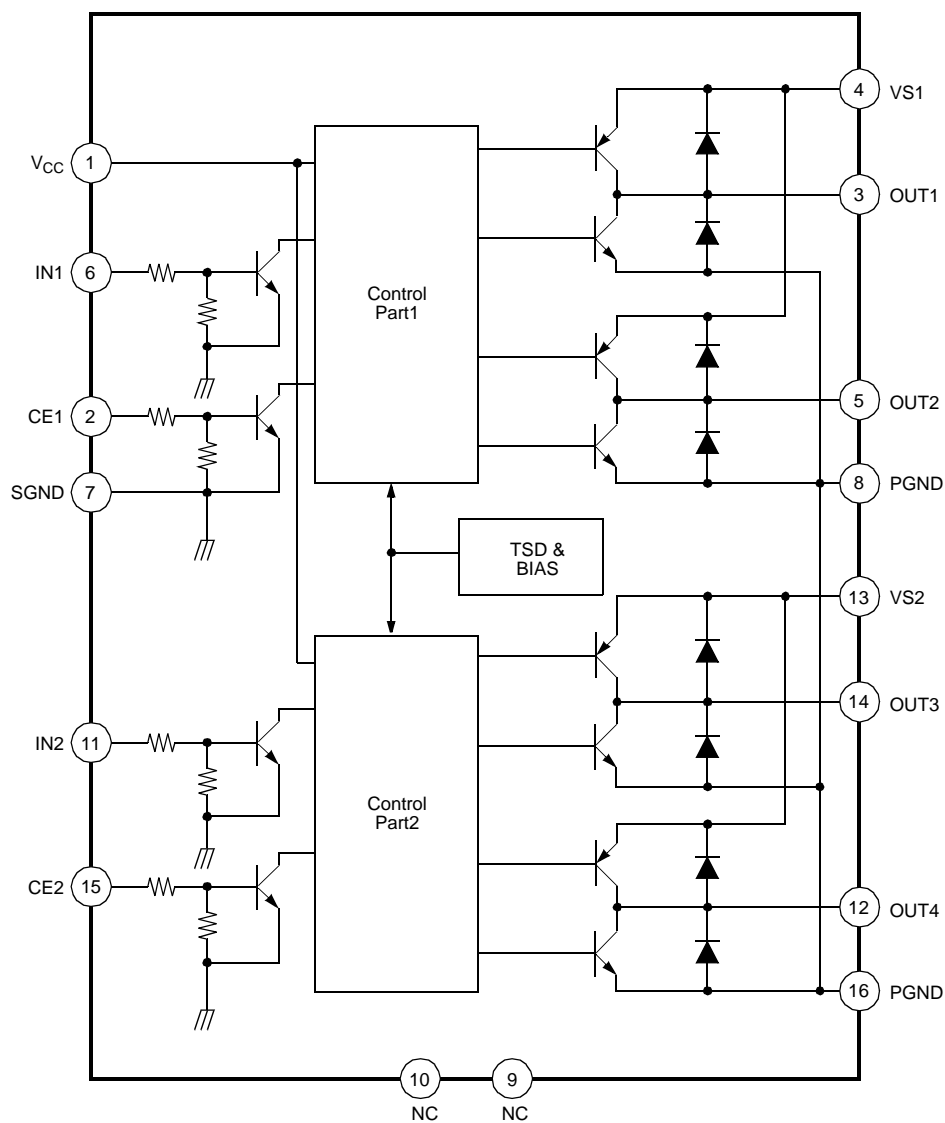
16-SOP-225



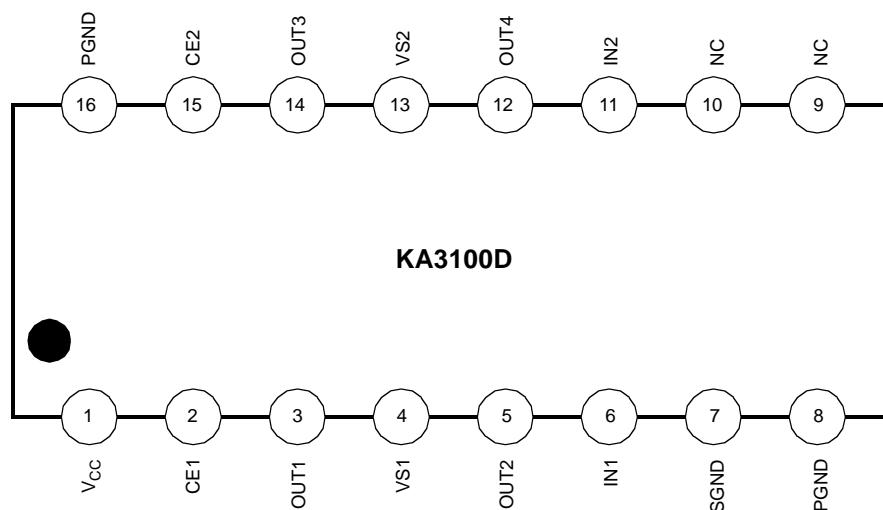
## ORDERING INFORMATION

Device	Package	Operating Temperature
KA3100D	16-SOP-225	-20 ~ +75°C

## BLOCK DIAGRAM



## PIN CONFIGURATION

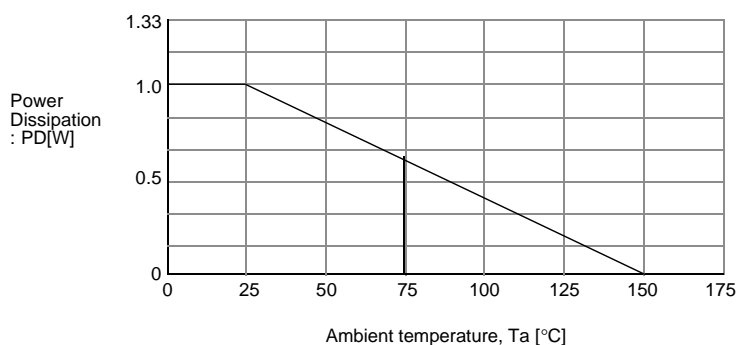


## PIN DESCRIPTION

Pin No.	Symbol	I/O	Description
1	V <sub>CC</sub>	–	Logic part supply voltage
2	CE1	I	Chip enable 1
3	OUT1	O	Output 1
4	VS1	–	Power supply 1
5	OUT2	O	Output 2
6	IN1	I	Input 1
7	SGND	–	Signal ground
8	PGND	–	Power ground
9	NC	–	No connection
10	NC	–	No connection
11	IN2	I	Input 2
12	OUT4	O	Output 4
13	VS2	–	Power supply 2
14	OUT3	O	Output 3
15	CE2	I	Chip enable 2
16	PGND	–	Power ground

**ABSOLUTE MAXIMUM RATING (Ta=25°C)**

Characteristics	Symbol	Value	Unit
Supply voltage	$V_{CC(MAX)}$	-0.3 ~ 9.0	V
Power supply voltage	$V_{S(MAX)}$	-0.3 ~ 9.0	V
Output voltage	$V_{OUT(MAX)}$	$V_S + V_{ef}$	V
Input voltage	$V_{IN(MAX)}$	-0.3 ~ 7.0	V
Peak output current	$I_{O(PEAK)}$	1	A
Continuous output current	$I_O$	0.4	A
Power dissipation	$P_D$	0.55	W
Junction temperature	$T_J$	150	°C
Storage temperature	$T_{STG}$	-40 ~ 125	°C
Operating temperature	$T_A$	-20 ~ 75	°C



Power dissipation decreases in the rate of 13.6mW / °C when mounted on 30mm × 30mm × 1.5mm PCB (Phenolic resin material) and used above Ta=25°C.

**RECOMMENDED OPERATING CONDITIONS**

Characteristics	Symbol	Min.	Typ.	Max.	Unit
Logic part supply voltage	$V_{CC}$	2.5	–	7.0	V
Power supply voltage	$V_S$	2.5	–	7.0	V

## ELECTRICAL CHARACTERISTICS

(Ta=25°C, V<sub>CC</sub>=5V, V<sub>S1</sub>=3V, V<sub>S2</sub>=3V, unless specified otherwise)

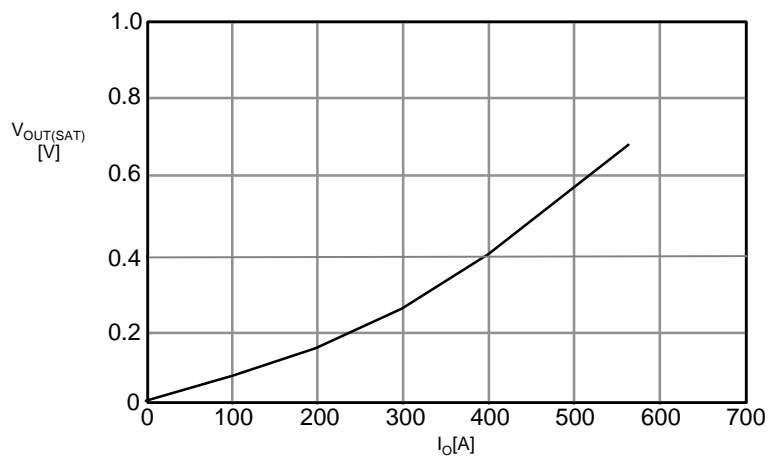
Characteristic	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Supply current 1	I <sub>CC1</sub>	CE1, 2=0V, V <sub>INL</sub> =3V or 0V, Each CH.	–	0.1	10	mA
Supply current 2	I <sub>CC2</sub>	CE1=3V, V <sub>INL</sub> =3V or 0V, Each CH.	–	12	18	mA
Saturation voltage 1	V <sub>SAT1</sub>	CE1=3V, V <sub>INL</sub> =3V or 0V, I <sub>OUT</sub> =0.2A	–	0.2	0.3	V
Saturation voltage 2	V <sub>SAT2</sub>	CE1=3V, V <sub>INL</sub> =3V or 0V, I <sub>OUT</sub> =0.4A	–	0.4	0.6	V
Input high level voltage	V <sub>INH</sub>	–	1.8	–	V <sub>CC</sub>	V
Input low level voltage	V <sub>INL</sub>	–	–0.3	–	0.7	V
Input current	I <sub>IN</sub>	V <sub>IN</sub> =3V, Each CH	–	100	200	mA
Chip enable current	I <sub>CE</sub>	CE=0V, Each CH	–	100	200	mA
Clamp diode leakage current	I <sub>LEAK</sub>	V <sub>CC</sub> =7V, V <sub>S</sub> =7V	–	–	30	mA
Clamp diode voltage	V <sub>EF</sub>	I <sub>OUT</sub> =0.4A	–	–	1.7	V

## FUNCTION DESCRIPTION

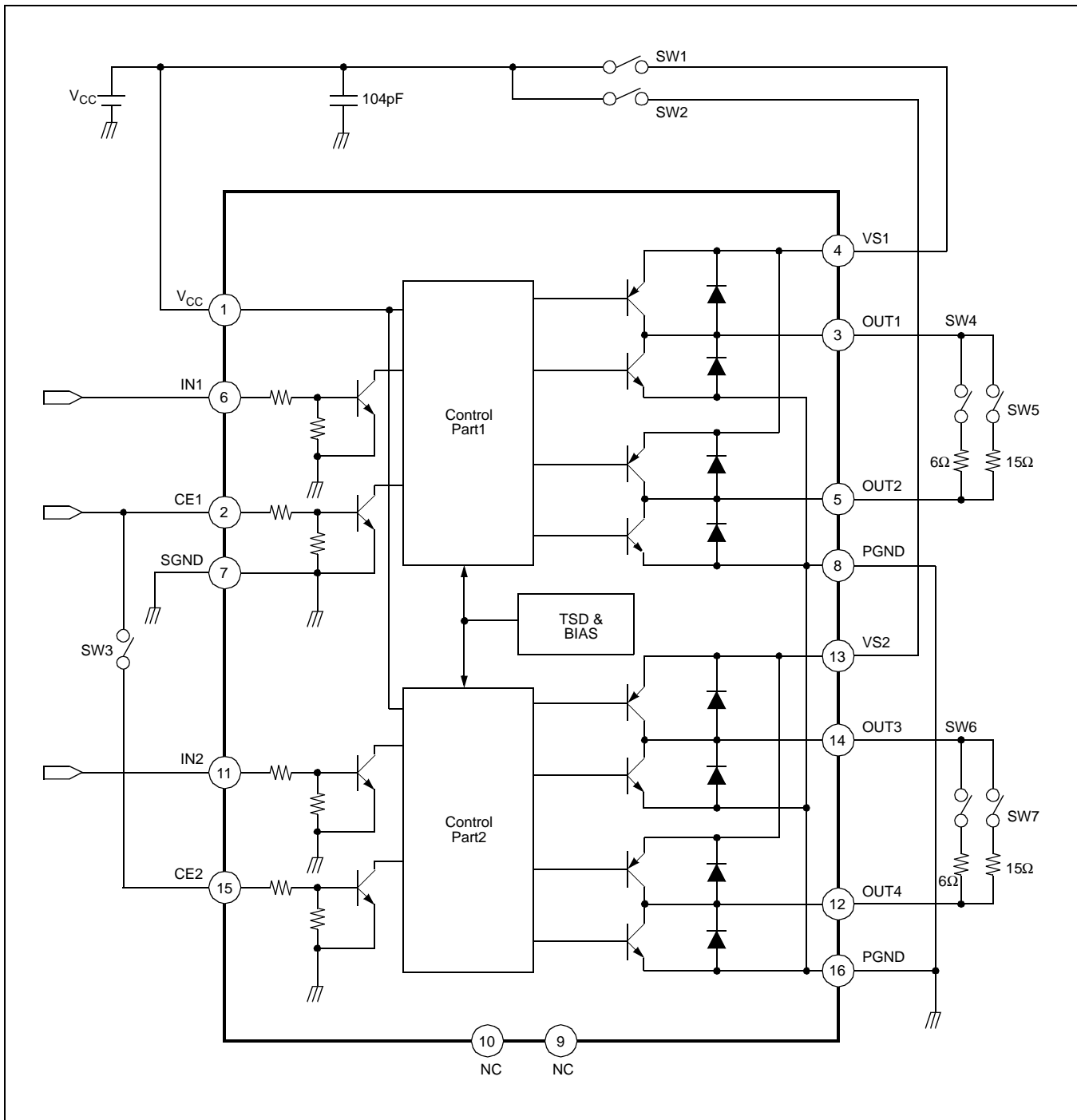
IN1 & IN2	CE1 & CE2	OUT1 & OUT3	OUT2 & OUT4	Motor rotation
Low	High	High	Low	Forward
High	High	Low	High	Reverse
Low	Low	Off	Off	Stand-by
High	Low	Off	Off	Stand-by

## GRAPHS

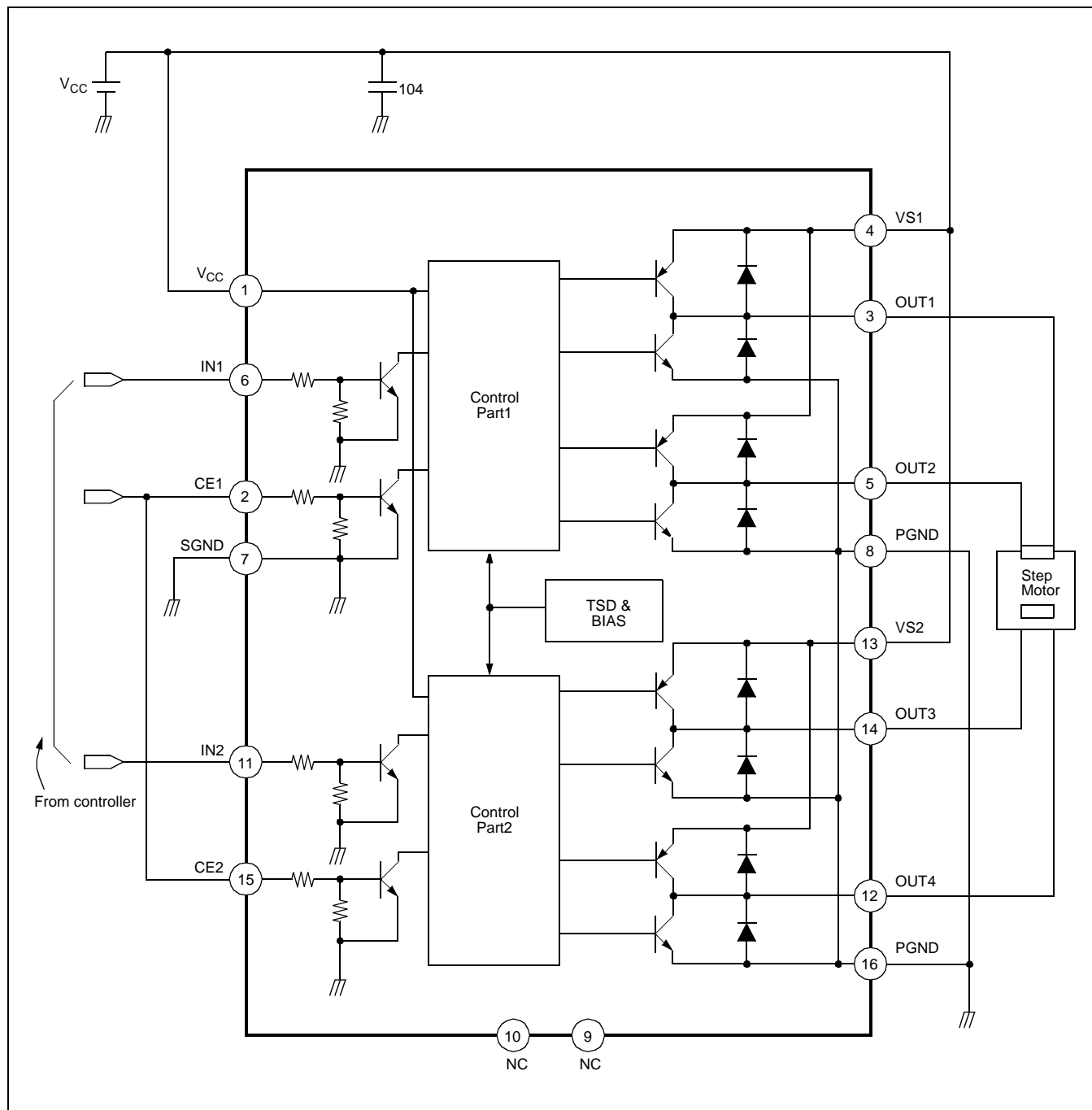
### 1. $V_{OUT(SAT)}$ VS $I_O$ CHARACTERISTIC GRAPH



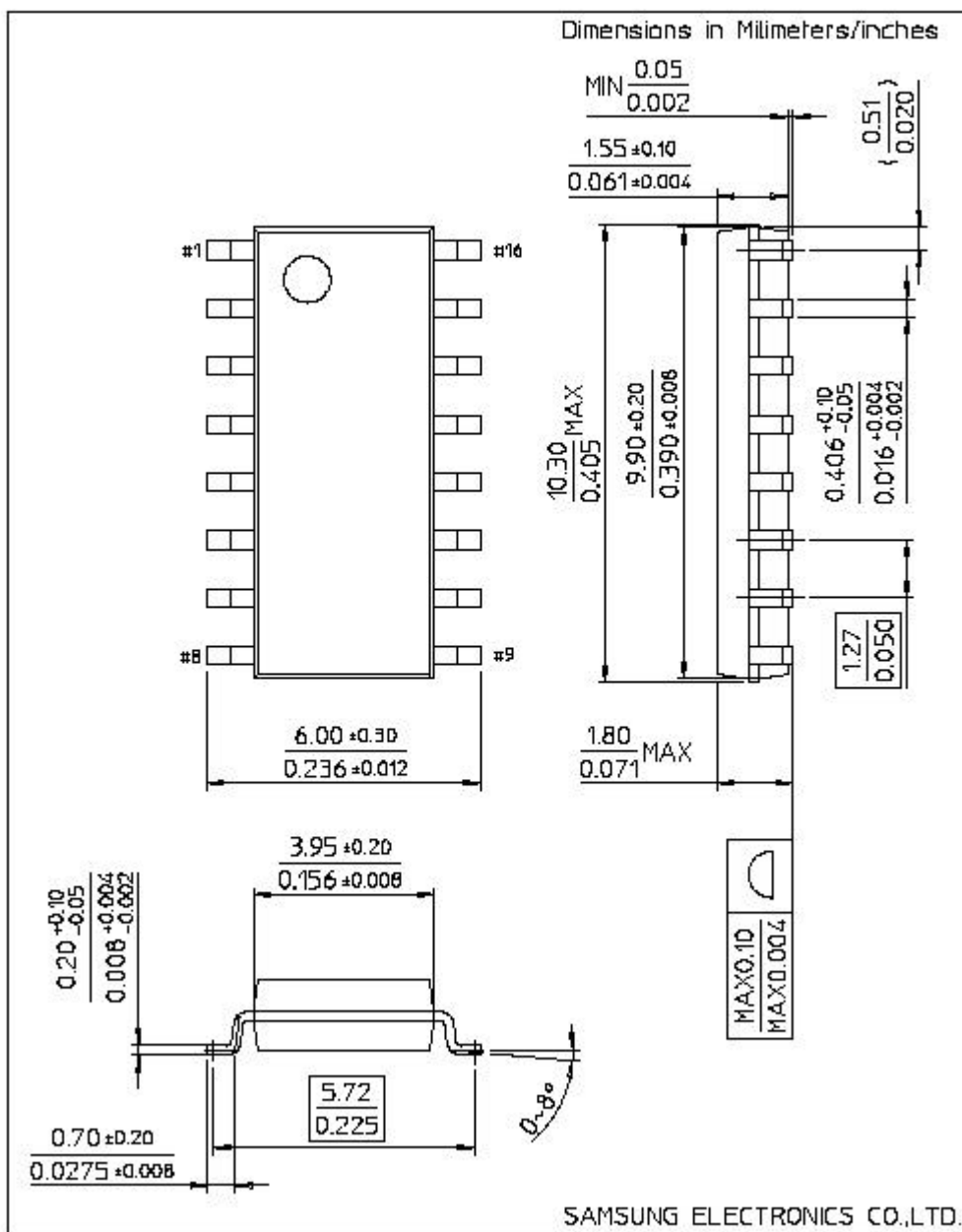
## TEST CIRCUIT



## APPLICATION CIRCUIT



**16-SOP-225**



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